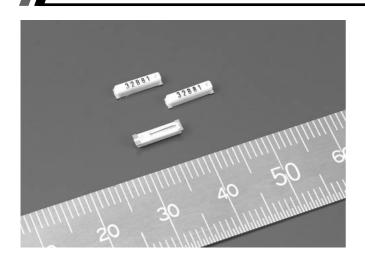
SSP-T Series (SSP-T6) Surface Mount Quartz Crystal Units for Low Frequencies



FEATURES

- Ultra thin type with height 1.6mm Max.
- Ultra small mounting area of 16.8mm²
- SMD type suitable for automatic & high density surface mounting.
- Plastic mold package containing highly reliable tubular type quartz crystal.
- Excellent shock and heat resistance.

APPLICATIONS

Cellular Phones, Pagers, Radio Communication Equipment, Portable Applications etc.

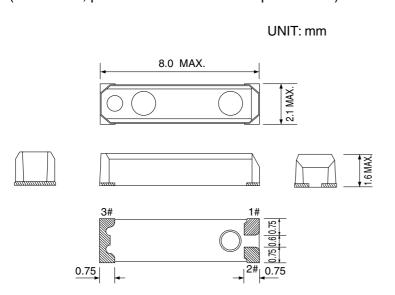
STANDARD SPECIFICATIONS

Conditions without notice (Temperature: +25°C±2°C)

| Item | Symbol | Specifications | Conditions / Notes |
|------------------------------|--------|--|---------------------------------------|
| Nominal Frequency | fo | 32.768kHz/75.000kHz | |
| Frequency Tolerance | △ f/fo | ±10ppm, ±20ppm, ±50ppm | Can be used in high accurate products |
| Turnover Temperature | Тр | +25°C±5°C | |
| Temperature Coefficient | К | (-3.5±1.0) x 10 ⁻⁸ /°C ² | |
| Load Capacitance | CL | 7.0pF/12.5pF | |
| Equivalent Series Resistance | R1 | 55kΩ max. | |
| Maximum Drive Level | DLmax | 1μW | |
| Recommended Drive Level | DL | 0.1μW | |
| Shunt Capacitance | Co | 0.95pF typ. | |
| Aging | △ f/fo | ±3ppm max. | +25°C±3°C, First Year |
| Operating Temperature Range | Tope | -40°C to +85°C | |
| Storage Temperature Range | Tsto | -55°C to +125°C | |
| Reflow Profile | Tsol | 230°C max. 20sec. x 2 times | IR Reflow |

DIMENSIONS

(For details, please refer to individual specification)



INTERNAL LEAD CONNECTION



RECOMMENDED SOLDERING PATTERN

UNIT: mm

20
0.4
0.85
0.85
0.85
0.85

Note: Please make sure that there is no electric wire line under SSP-T6 on the circuit board.